

Compact High Accuracy Temperature Sensor ICs

Low current Thermostat Output Temperature Sensor ICs



BDJ□□□0HFV Series

No.11047EBT05

●Description

BDJ□□□0HFV series is thermostat output temperature sensor IC with built-in temperature detection element, constant current circuit, high-accuracy reference voltage source in one chip. Temperature detection can be realized at $\pm 2.5^{\circ}\text{C}$ accuracy without complicated design. It is the best temperature sensor IC for a portable equipment of micro and low current, the power down function, and the battery drive. It is possible to use it for a wide usage such as the heat detection and temperature monitors because it provides with the analog output in addition to the thermostat power output. BDJ□□□0HFV series has 5 products at 55°C , 60°C , 65°C , 70°C , 80°C detection temperature.

●Features

- 1) Detection Temperature lineup at 55°C , 60°C , 65°C , 70°C , 80°C (5 products)
- 2) Power supply Voltage range $2.4 \sim 5.5\text{V}$.
- 3) High Accuracy thermostat (typ. $\pm 1.0^{\circ}\text{C}$, max. $\pm 2.5^{\circ}\text{C}$ @ $T_a = 55 \sim 80^{\circ}\text{C}$)
- 4) High Accuracy Analog Output (typ. $\pm 1.0^{\circ}\text{C}$, max. $\pm 2.5^{\circ}\text{C}$ @ $T_a = -30 \sim 100^{\circ}\text{C}$)
- 5) Analog Output Temperature Sensitivity (typ. $-8.2\text{mV}/^{\circ}\text{C}$)
- 6) Low Supply Current (typ. $7.5\mu\text{A}$)
- 7) Power down control function built in. (PD interface Voltage min 1.5V)
- 8) Small Package (typ. $1.60\text{mm} \times 1.60\text{mm} \times 0.60\text{mm}$)
- 9) Low thermal resistance package (typ. $187^{\circ}\text{C}/\text{W}$)
- 10) ESD Rating 8kV (HBM)

●Applications

Cell phone, Digital Camera, Thermal Protection for Electrical Equipment (NoteBook PC, FPD-TV, etc.)

●Line up matrix

Product Name	Detect Temp. ($^{\circ}\text{C}$)	OS Output Format		Marking
BDJ0800HFV	80	Open Drain	Active L	ff
BDJ0700HFV	70	Open Drain	Active L	fh
BDJ0650HFV	65	Open Drain	Active L	fk

Product Name	Detect Temp. ($^{\circ}\text{C}$)	OS Output Format		Marking
BDJ0600HFV	60	Open Drain	Active L	fm
BDJ0550HFV	55	Open Drain	Active L	fn

●Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Power Supply Voltage	V _{DD}	-0.3 to 7.0 ^{*1}	V
Input Voltage (PD)	V _{IN}	-0.3 to V _{DD} +0.3	V
OS terminal Voltage	V _{OS}	-0.3 to 7.0 ^{*1}	V
OS terminal Current	I _{OS}	5.0	mA
Power dissipation	P _d	536 ^{*2}	mW
Storage Temperature Range	T _{stg}	-55 to 150	°C

*1. Not to exceed P_d

*2. Reduced by 5.36mW for each increase in Ta of 1°C over 25°C
(mounted on 70mm × 70mm × 1.6mm Glass-epoxy PCB)

●Recommended Operating Conditions

Parameter	Symbol	Ratings			Unit
		Min.	Typ.	Max.	
Power Supply Voltage	V _{DD}	2.4	2.8	5.5	V
Operating Temperature Range	T _{opr}	-30	-	100	°C

●Electrical Characteristics (Unless otherwise specified, V_{DD} = 2.8V, Ta = 25°C)

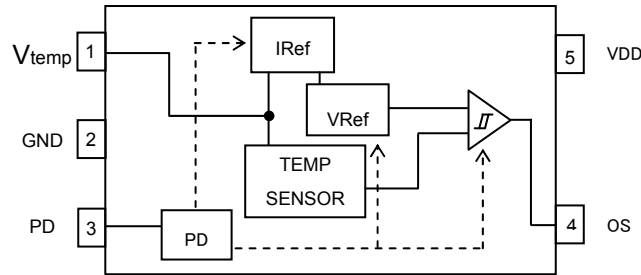
Parameter		Symbol	Limits			Unit	Conditions
			Min.	Typ.	Max.		
Supply Current							
	Normal function mode	IDD	-	7.5	12.0	μA	PD=“H”
	Power Down mode	IDDPD	-	0.3	1.0	μA	PD=“L”
PD							
	Input L Voltage	VIL	GND	-	0.2	V	
	Input H Voltage	VIH	1.5	-	VDD	V	
	PD Leakage Current	ILPD	-	-	1.0	μA	PD=2.8V
Analog Output							
	VTemp Output Voltage	Vtemp	1.279	1.300	1.321	V	Ta = 30℃
	VTemp Temperature Sensitivity	VSE	-8.00	-8.20	-8.40	mV/℃	Ta = -30 to 100℃
	VTemp Load Regulation	ΔVtempRL	-	-	1.0	mV	difference of IOUT : 0uA / 2μA
	Vtemp VDD Regulation	ΔVtempVDD	-	-	4.0	mV	VDD=2.4~5.5V
OS Output Open Drain							
	OS Leakage Current	IL	-	-	1.0	μA	VOS =5.0V
	OS Output Voltage	VOL	-	-	0.4	V	Ios = 1.0mA

Radiation hardness is not designed.

●Temperature Accuracy (Unless otherwise specified, V_{DD} = 2.8V)

Parameter	Symbol	Limits			Unit	Conditions
		Min.	Typ.	Max.		
Thermostat						
Sensing Temperature Accuracy	Tacc	-	±1.0	±2.5	°C	
Sensing Temperature Hysteresis	Thys	7.5	10.0	12.5	°C	
Analog Output						
Vtemp Temperature Accuracy	Ttemp	-	±1.0	±2.5	°C	VDD = 2.8V Ta = -30 to 100°C

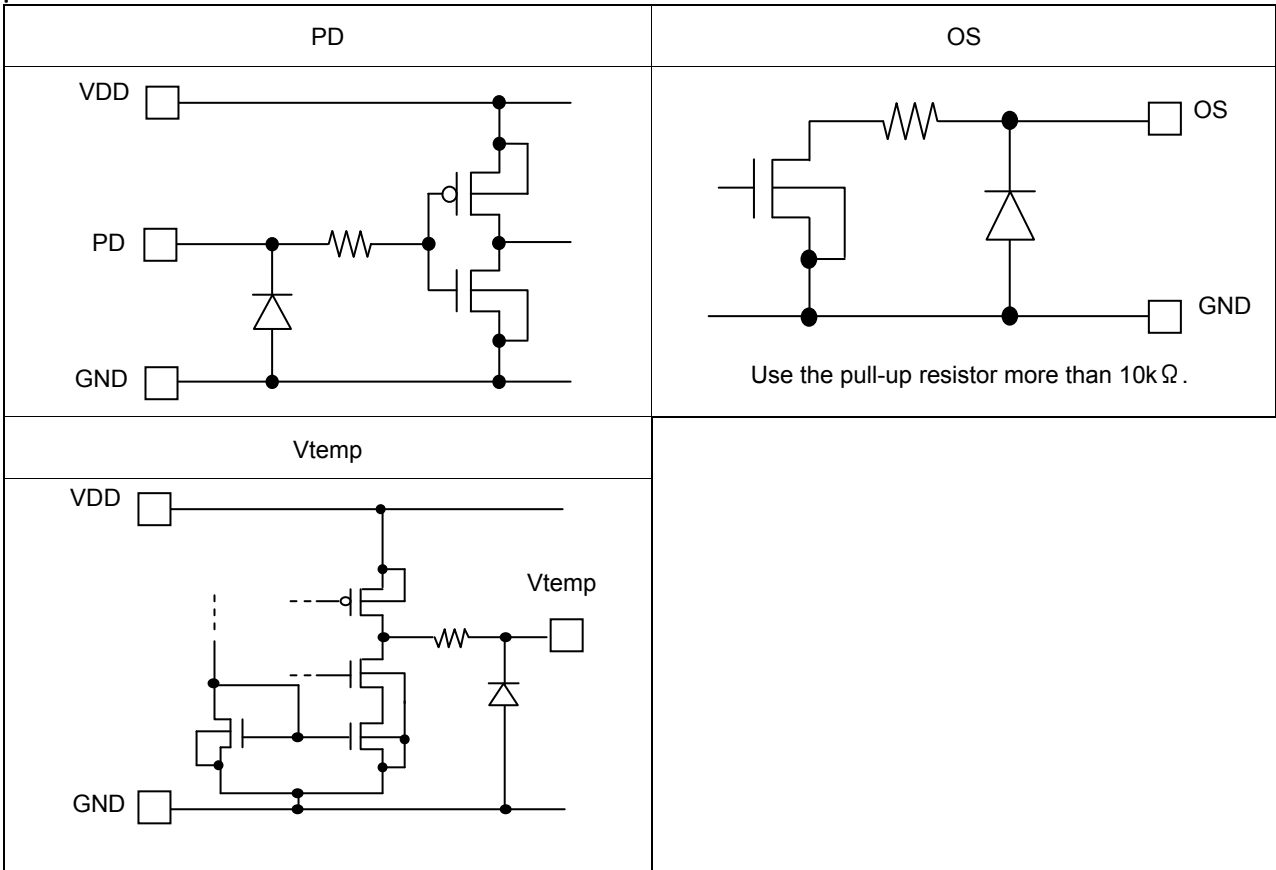
●Block Diagram



●Pin Description

PIN NO.	PIN NAME	FUNCTION	COMMENT
1	Vtemp	Output voltage in inverse proportion to the temperature (TYP. -8.20mV/°C)	Set the OPEN state or connect high impedance input node.(over 10MΩ)
2	GND	GROUND	
3	PD	PD control H : Normal function mode L : Power Down mode	"H" Thermostat and Analog output operation. "L" Power Down state.
4	OS	Digital thermostat output	Open Drain Active L. Use the pull-up resistor more than 10kΩ.
5	VDD	POWER SUPPLY	

●Equivalent Circuit



●Reference Data

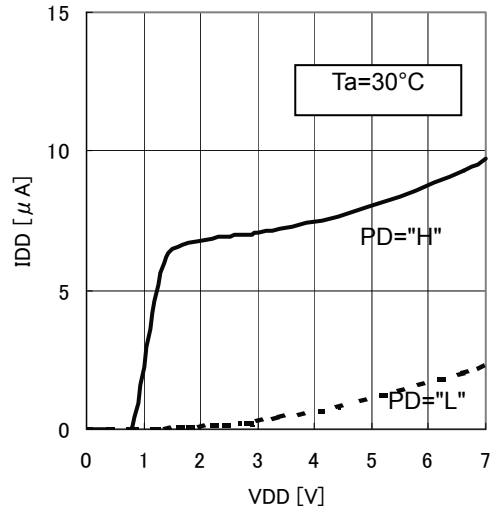


Fig1. Supply Current(IDD) vs. Supply Voltage

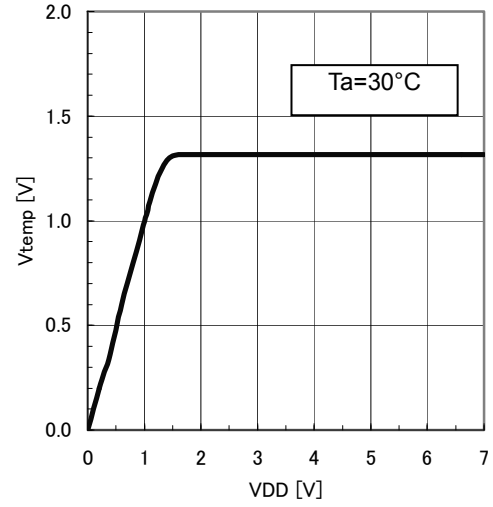


Fig2. Vtemp Voltage vs. Supply Voltage

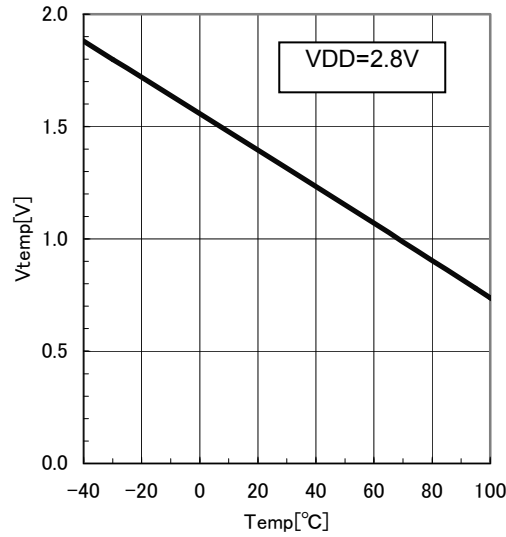


Fig3. Vtemp Voltage vs. Temperature

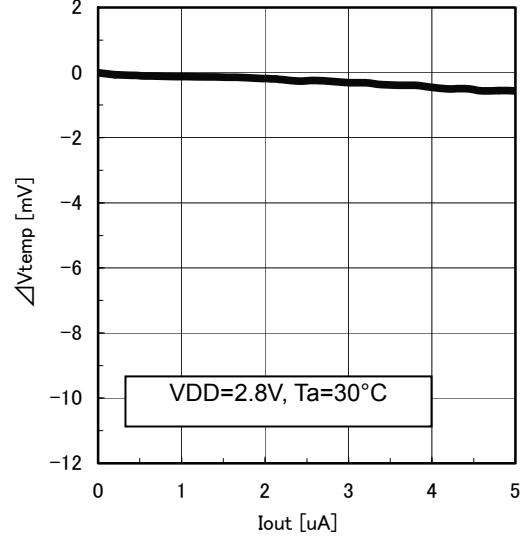


Fig4. Vtemp Voltage vs. Output Current

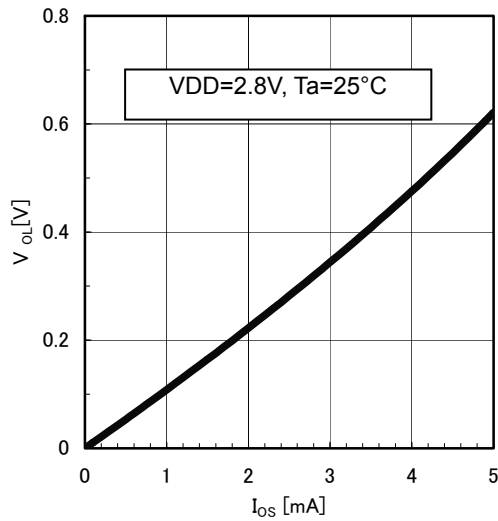


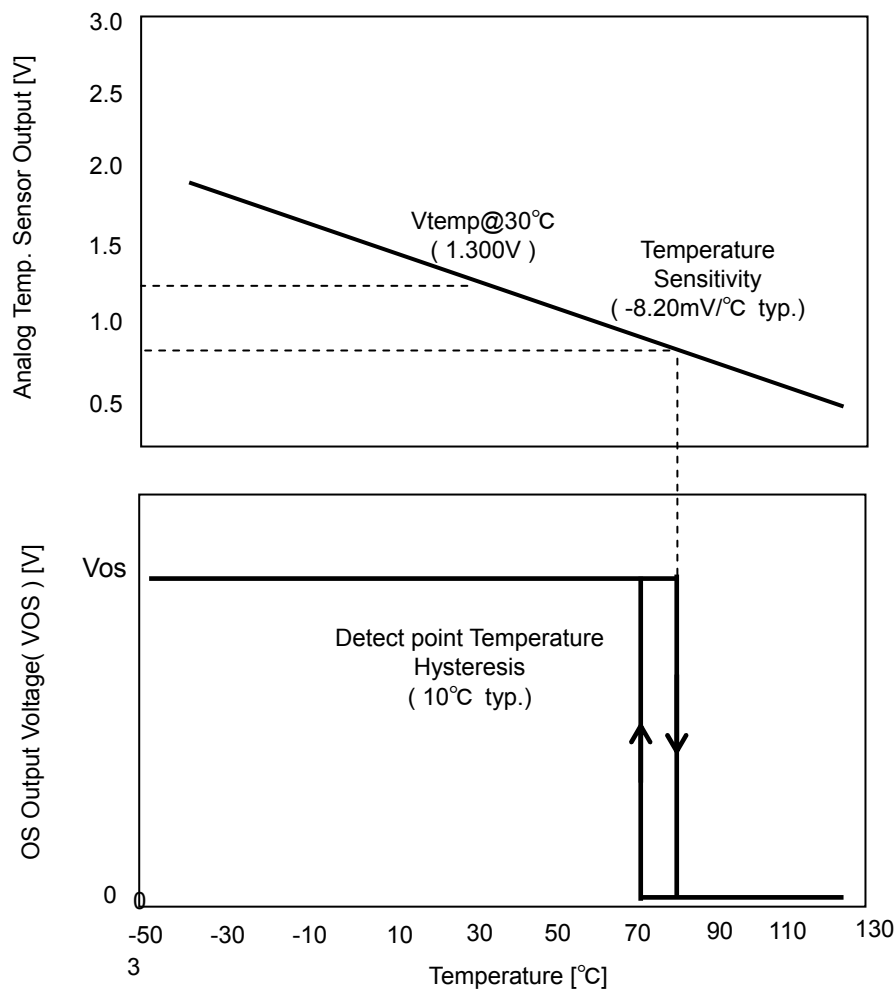
Fig5. OS Output Voltage vs. Load Current

●Function Diagram(ex. 80°C detect Active "L" type BDJ0800HFV)

Temperature sensor internal IC sense temperature, Vtemp terminal output voltage convert temperature.

Vtemp value is 1.300[V] at $T_a = 30[^\circ\text{C}]$.

The value of Vtemp voltage reduce reversely proportional temperature at rate of $-8.2\text{mV}/^\circ\text{C}$.

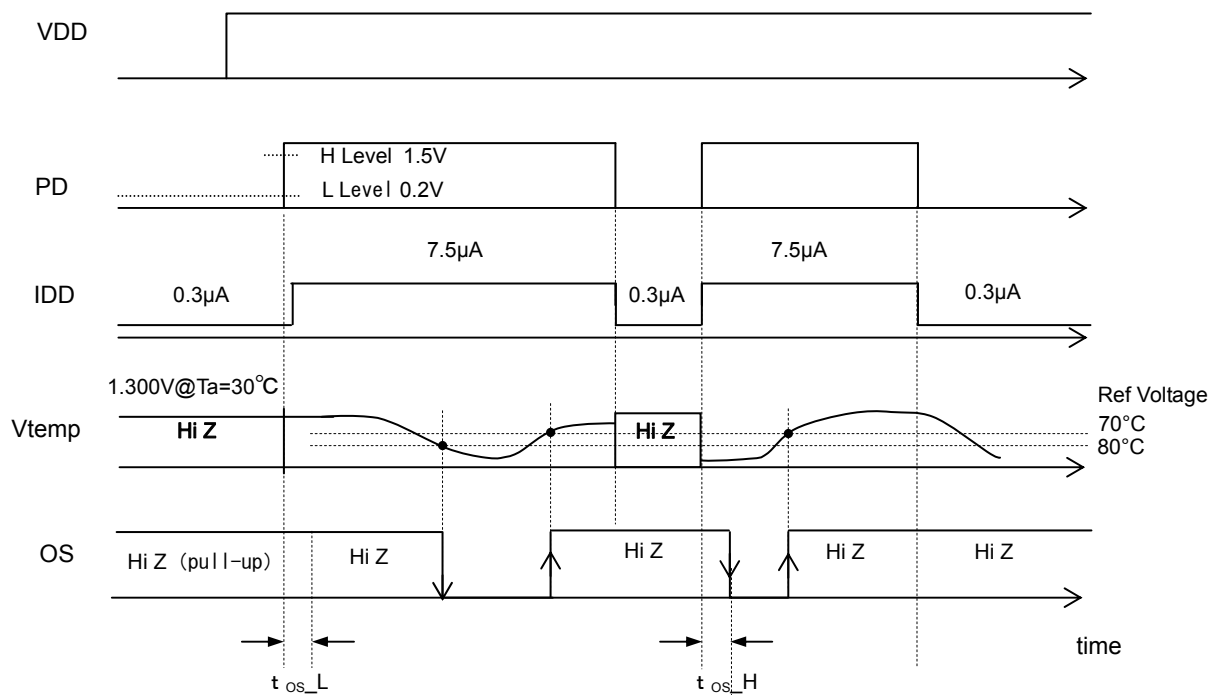


If the temperature over detect temperature, internal comparator operate OS output "H" to "L".(ex.active "L" Type)

In case of OS return to "H",the temperature 10°C lower than detect temperature.

●Operation Sequence

(ex.80°C detect Active "L" type BDJ0800HFV)



BDJ0800HFV operate start after PD "H" Input.

Please read OS terminal signal below wait time after PD "H" Input.

Ta	Symbol	Wait time
Under detect Temp.	t_{os_L}	200μs
Over detect Temp.	t_{os_H}	1000μs

●Notes for use

- 1) Absolute Maximum Ratings
An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.
- 2) GND voltage
Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state.
- 3) Pin short and mistake fitting
When mounting the IC on the PCB, pay attention to the orientation of the IC. If there is a placement mistake, the IC may be burned up.
- 4) Operation in strong electric field
Be noted that using ICs in the strong electric field can malfunction them.
- 5) Mutual impedance
Use short and wide wiring tracks for the power supply and ground to keep the mutual impedance as small as possible.
Use a capacitor to keep ripple to a minimum.

●Ordering part number

B	D	J
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Series Name

0	8	0	0
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Detect Temp.

080: 80°C
070: 70°C
065: 65°C
060: 60°C
055: 55°C

Output Format

0 : active L
1 : active H

H	F	V
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Package

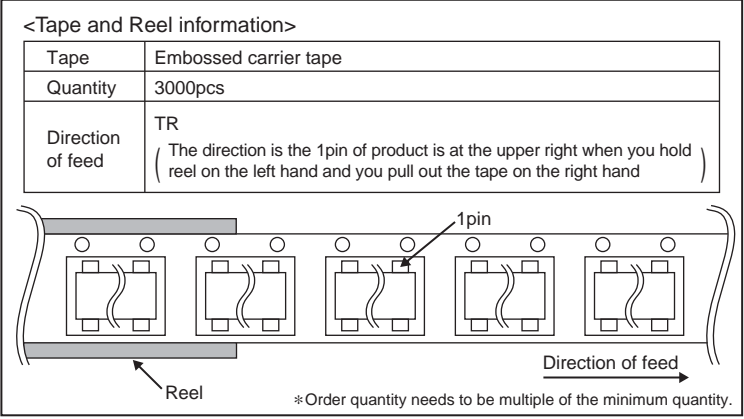
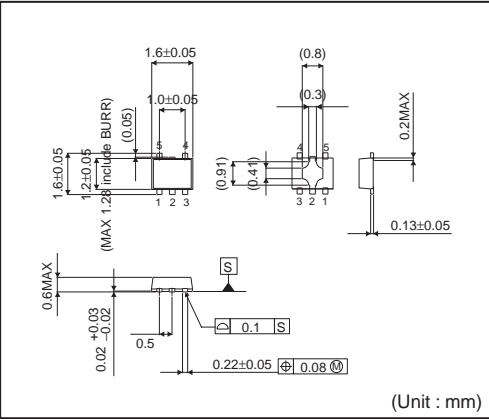
HFV:HVSOF5

T	R
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Packaging and forming specification

TR: Embossed tape and reel

HVSOF5



Notice

Precaution on using ROHM Products

- Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

- ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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